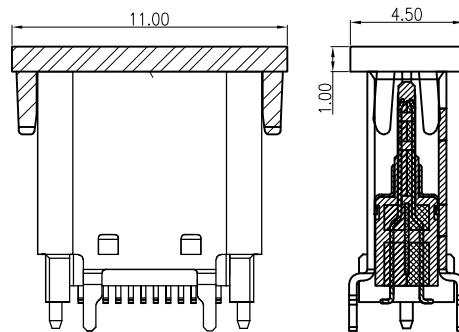
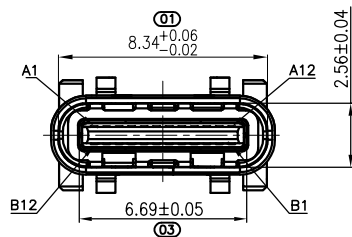
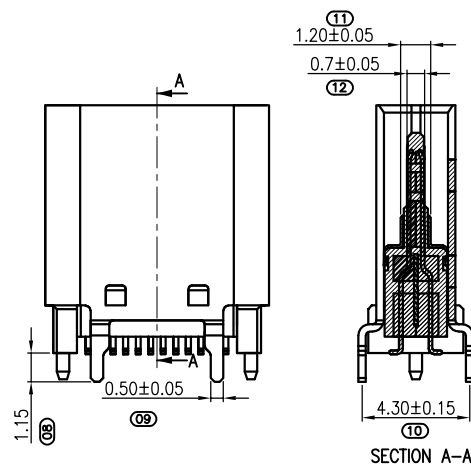
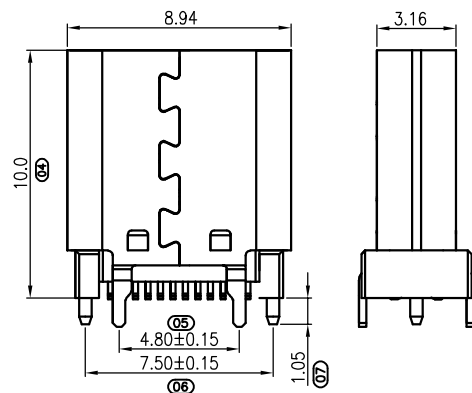


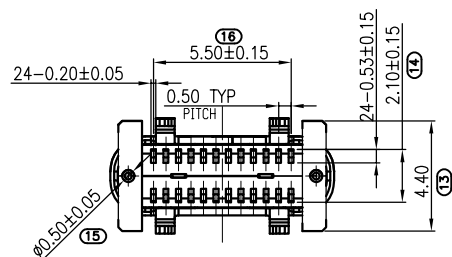
RoHS



装吸取盖示意图



SECTION A-A



PIN NUMBER	SIGNAL NAME	PIN NUMBER	SIGNAL NAME
A1	GND	B12	GND
A2	SSTXp1	B11	SSRXp1
A3	SSTXn1	B10	SSRXn1
A4	VBUS	B9	VBUS
A5	CC1	B8	SBU2
A6	Dp1	B7	Dn2
A7	Dn1	B6	Dp2
A8	SBU1	B5	CC2
A9	VBUS	B4	VBUS
A10	SSRXn2	B3	SSTXn2
A11	SSRXp2	B2	SSTXp2
A12	GND	B1	GND

MILLIMETERS	INCH
X° ± 2°	X° ± 2°
.X ± 0.35	.XX ± 0.014
.XX ± 0.25	.XXX ± 0.010
.XXX ± 0.15	.XXXX ± 0.006

UNITS	MM
MAT'L	
SEE NOTES	
FINISH	
SEE NOTES	
QTY	
SEE NOTES	

XB 东莞市溪榜电子有限公司 DONG GUAN XI BANG ELECTRONICS CO., LTD.			
PART NUMBER: XB-104316822		TITLE: TYPE C 24PIN立式SMT 10.0H	
APPD:		DWG NO.: C-104316822-00	
CHKD:		SCALE	
DR: YSH		SHEET	
		REV.	
		1:1	
		1/2	
		A0	

NOTES:

1.MATERIAL:

1.1 HOUSING: LCP+30%G.F UL94V-0 BLACK

1.2 CONTACT: C7025, T=0.15mm;

Au 1u" PALTED ON CONTACT AREA & G/F SOLDER AREA PLATED OVER 50u" min Ni

1.3 SHELL: SUS304, T=0.30mm; 50U" MIN Ni PLATED OVERALL

1.4 MID PLATE: SUS301, T=0.15mm;

2.SPECIFICATION:

2.1 CURRENT RATING: 5A

2.2 CONTACT RESISTANCE: 40mΩ MAX(initial value)
50mΩ MAX(after test)

2.3 INSULATION RESISTANCE: 100MΩ MIN

2.4 WITHSTANDING VOLTAGE: 100V AC R.M.S.

2.5 INSERTION FORCE: 5-20N INSERTION FORCE: 5-20N (after test)

UNMATING FORCE: 8-20N UNMATING FORCE: 6-20N (after test)

2.6 DURABILITY: 10000CYCLES.

2.7 HIGH TEMPERATURE RESISTANCE: SMT reflow soldering (peak 260°±5°), plastic can not have blister, Poor melting glue, discoloration, warping deformation within the tolerance range ;

2.8 THE PRODUCT SHALL BE TESTED FOR SOLDERING AND THE SOLDERING AREA SHALL REACH MORE THAN 95%

2.9 Salt spray: 24H min

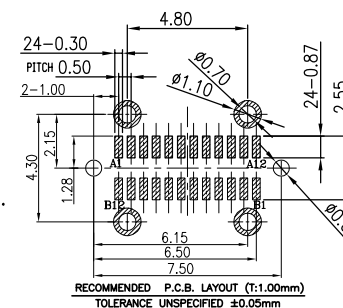
3. OPERATING TEMPERATURE: -30℃~+85℃

PART No.:

USB SERIES
PLATING:

31: Au1u+G/F

104316822

PAKING:
2: REEL
SERIAL NO.

RoHS

